PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
ZE-SEN FU	08/31/2011
REN-WEI TSENG	08/31/2011

RECEIVING PARTY DATA

Name:	INNOCOM TECHNOLOGY (SHENZHEN) CO., LTD.	
Street Address:	Street Address: 1F, E4 Building, E Block, Foxconn Science Park,Longhua Town, Bao' an District	
City:	Shenzhen City, Guangdong Province	
State/Country:	CHINA	

Name:	Chimei Innolux Corporation
Street Address:	No. 160 Kesyue Rd., Chu-Nan Site,Hsinchu Science Park, Chu-Nan 350
City:	Miao-Li County
State/Country:	TAIWAN

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13221923

CORRESPONDENCE DATA

Fax Number: (909)978-6366

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 9099786584

Email: Raymond.Chew@foxconn.com

Correspondent Name: Raymond J. Chew Address Line 1: 288 South Mayo Avenue

Address Line 4: City of Industry, CALIFORNIA 91789

ATTORNEY DOCKET NUMBER:

NAME OF SUBMITTER: Raymond J. Chew

Total Attachments: 2

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> **PATENT** REEL: 026832 FRAME: 0405

US34624

Attorney Docket No.: US34624

ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

ZE-SEN FU	, residing at	Shenzhen, Guangdong, China
REN-WEI TSENG	, residing at	Miao-Li, Taiwan
	, residing at	

hereby sell(s), assign(s) and transfer(s) unto: INNOCOM TECHNOLOGY (SHENZHEN) CO., LTD. having a principal place of business at 1F, E4 Building, E Block, Foxconn Science Park, Longhua Town, Bao' an District, Shenzhen City, Guangdong Province 518109, P.R.C. and CHIMEI INNOLUX CORPORATION having a principal place of business at No. 160 Kesyue Rd., Chu-Nan Site, Hsinchu Science Park, Chu-Nan 350, Miao-Li County, Taiwan, R.O.C. hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as SWITCH MODULE, ELECTRONIC DEVICE USING THE SAME AND METHOD FOR MANUFACTURING THE SAME for which the undersigned

[] previously executed Ser. No	and filing date of	
[x]	is executing concurrently herewith		

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

PATENT REEL: 026832 FRAME: 0406

1.	ZE-SEN FU	August 31,2011	
••	ZE-SEN FU	Date	
2.	REN-WEI TSENG	August 31,2011	
	REN-WEI TSENG	Date	
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PATENT REEL: 026832 FRAME: 0407